

Fundamentals and Applications of Vacuum Microelectronics

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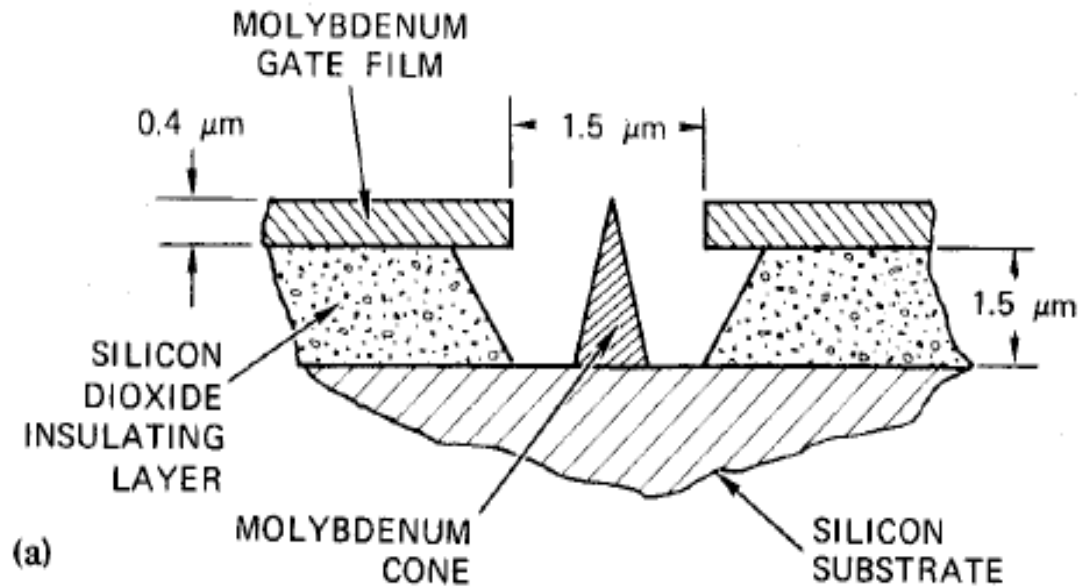
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Outline

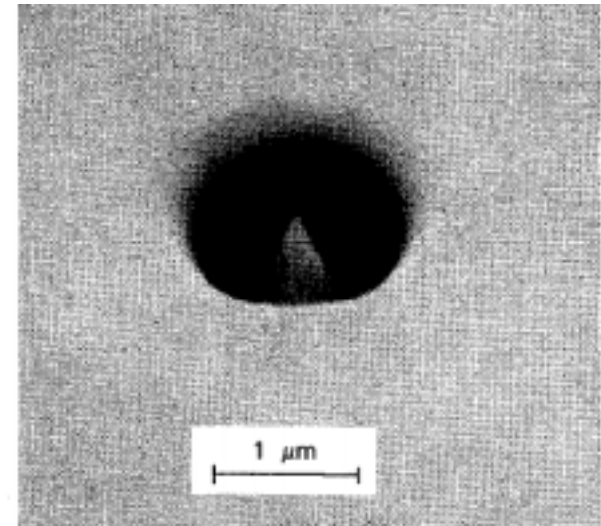
- Introduction
- Field emission basics
- Spindt emitters and arrays
- Beyond Spindt emitters
- Field emission display
- Summary

Introduction (I)

- What is vacuum microelectronics



[Ref. 1]

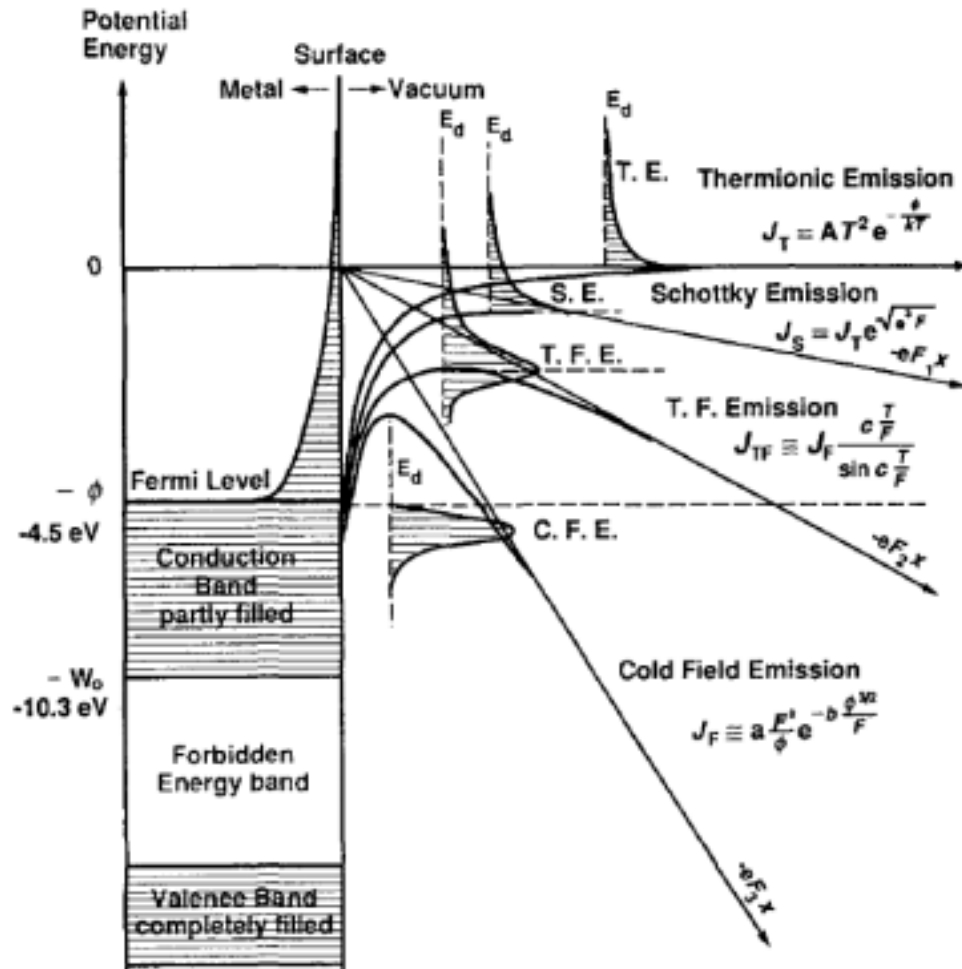


[Ref. 1]

Introduction (II)

- Good
 - Power handling ability
 - Ballistic and coherent transport
 - Resistance to radiation-induced defects
- Bad
 - Fabrication difficulties
 - Packaging issues

Field emission basics



F-N equation [Ref. 2]

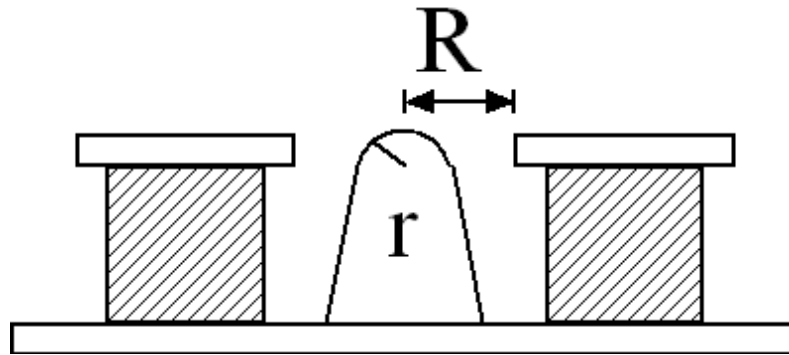
$$J(F, \phi) = a \frac{F^2}{\phi} e^{-b \frac{\phi^{3/2}}{F}}$$

$$a \approx 1.54 \times 10^{-6}$$

$$b = 6.83 \times 10^{-7} f(y)$$

F	$f(y)$	When
4.5×10^7	0.61	$\phi = 4.5 \text{ eV}$
6.4×10^7	0.49	
10.5×10^7	0.25	

Spindt emitters and arrays (I)



$$E = \beta V$$

E: electric field (V/m)

V: applied voltage (V)

$$\beta = R / (k r (R - r)) \sim 1 / (k r)$$

when $r \ll R$ [Ref. 3]

k: const. $1 < k < 5$

Assuming field emission onset
 $E \sim 1 \times 10^7$ V/cm

Classical processing:

$$R = 1 \text{ mm} , r = 2000 \text{ \AA}$$

$$\beta = 5 \times 10^4 / k \text{ cm}^{-1}$$

$$\rightarrow V = 1000 \text{ V}$$

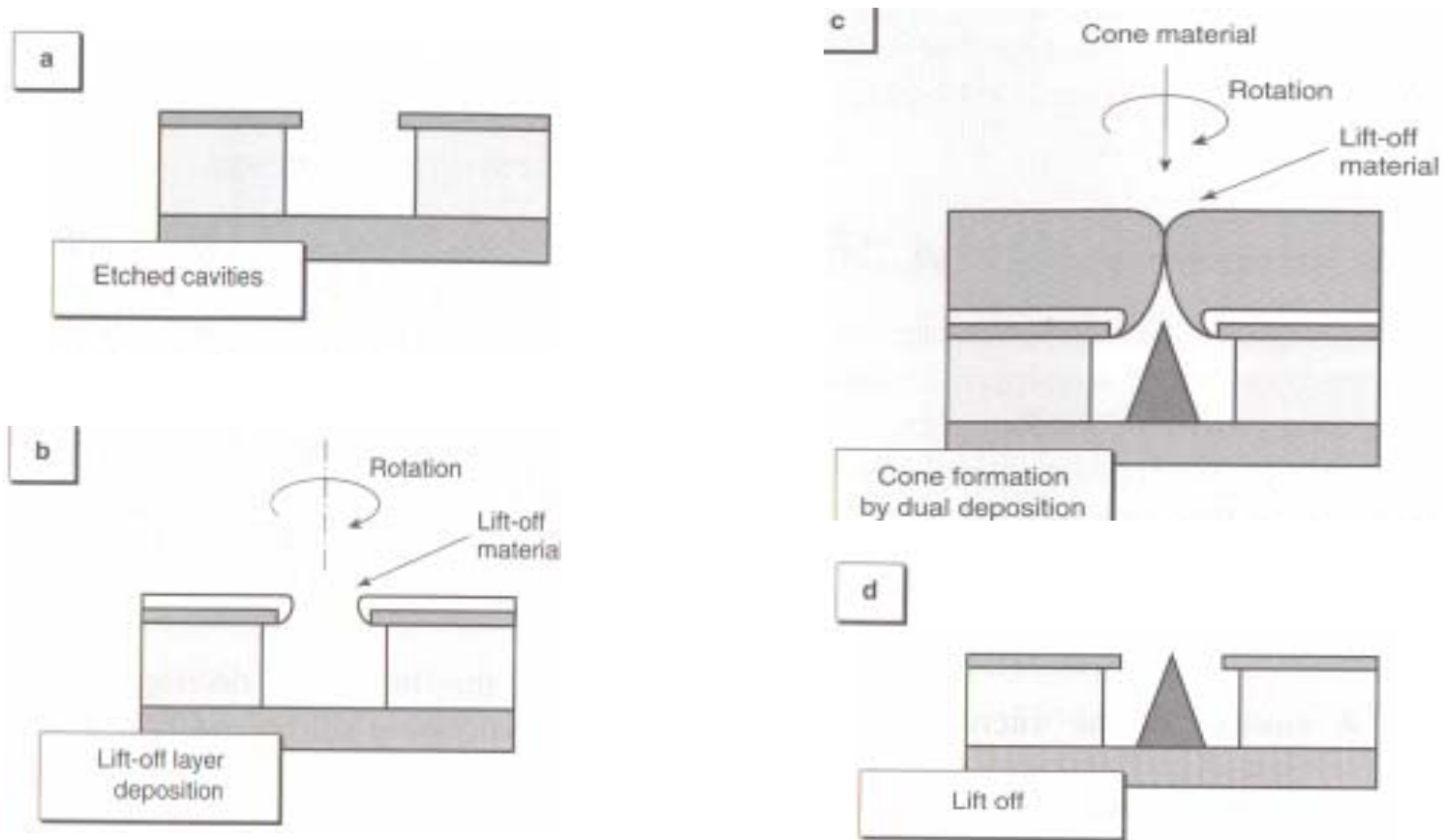
Micro-fabrication:

$$R = 5000 \text{ \AA} , r = 250 \text{ \AA}$$

$$\beta = 4 \times 10^5 / k \text{ cm}^{-1}$$

$$\rightarrow V = 100 \text{ V}$$

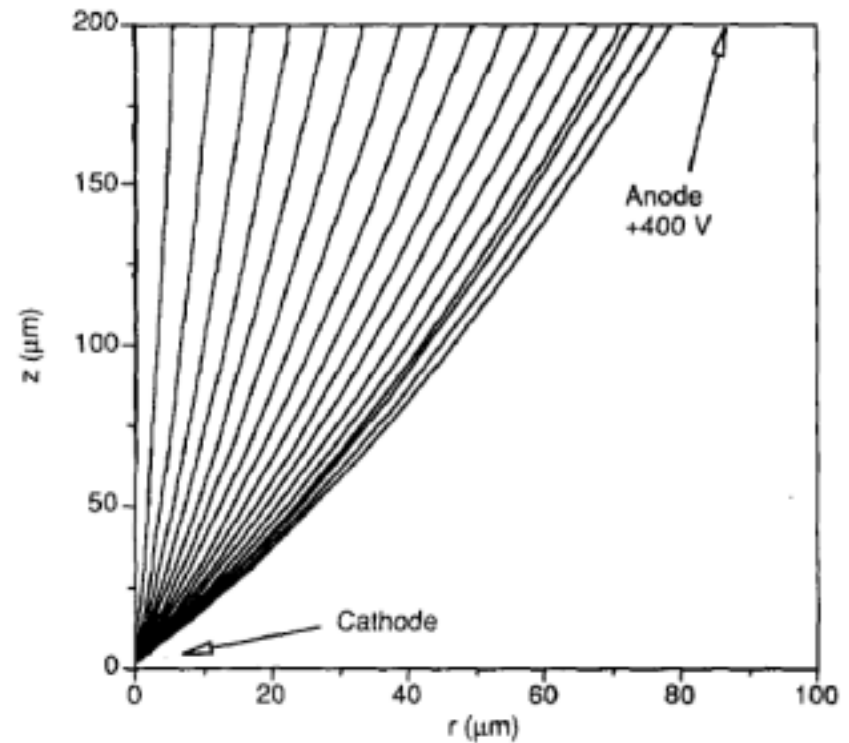
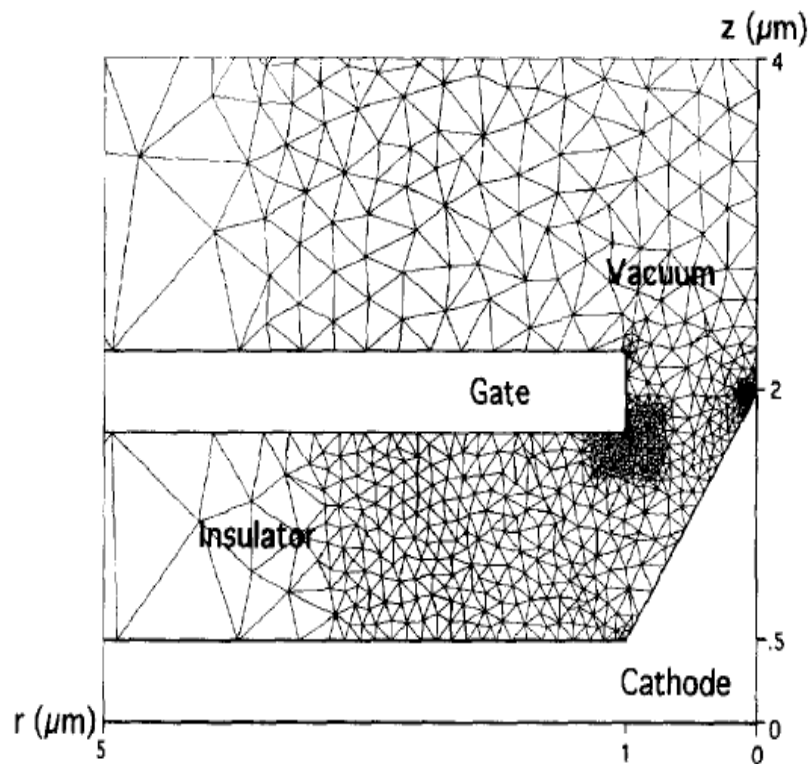
Spindt emitters and arrays (II)



[Ref. 3]

Spindt emitters and arrays (III)

- Fields of a triode structure [Ref. 4]



Spindt emitters and arrays (IV)

- Structure parameter dependence [Ref. 5]

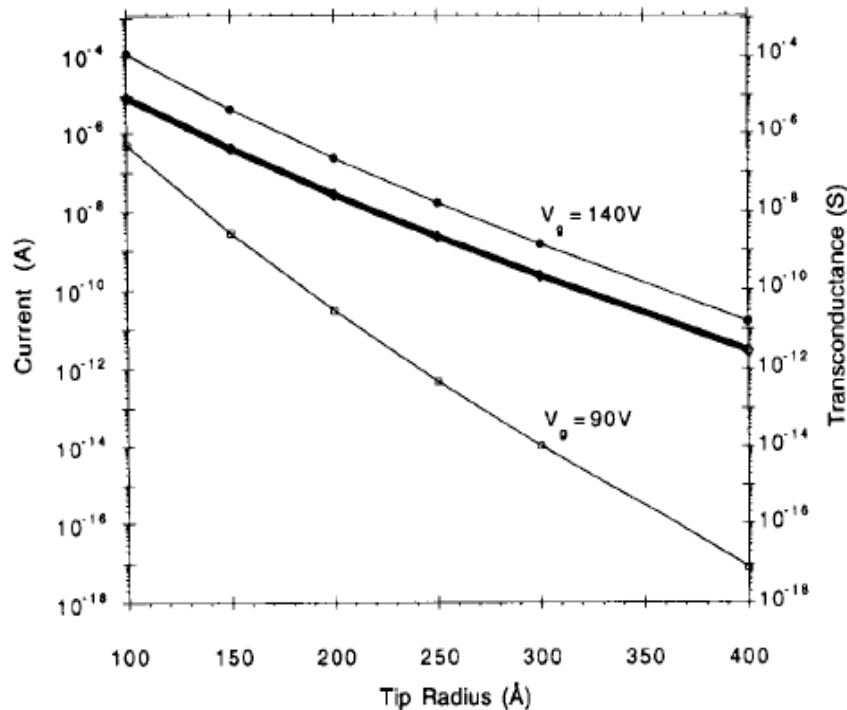


Fig. 4. Emitted current as a function of tip radius at 90 V (lower curve) and 140 V (upper curve). Transconductance at 140 V is indicated in bold.

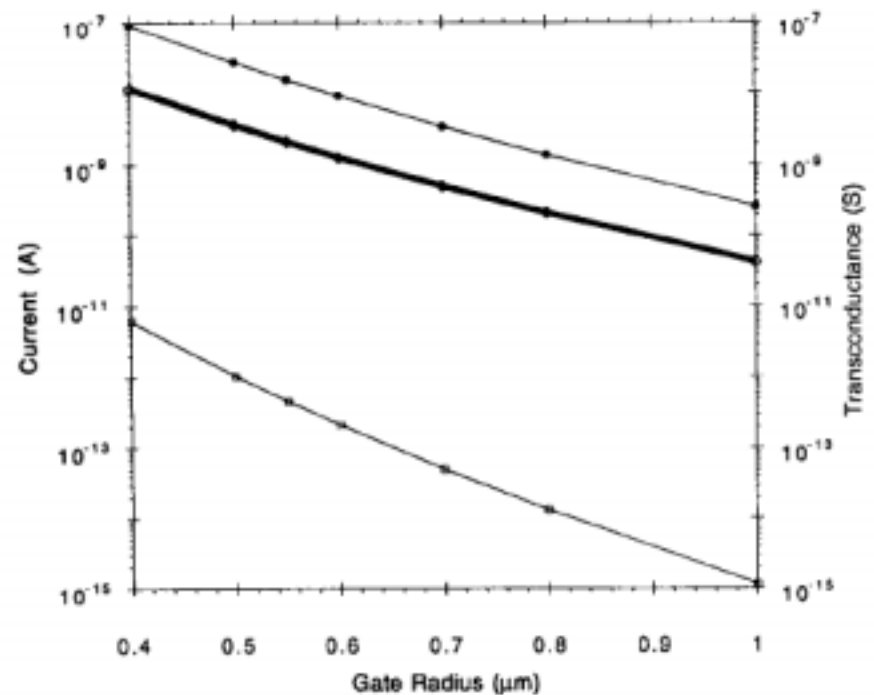
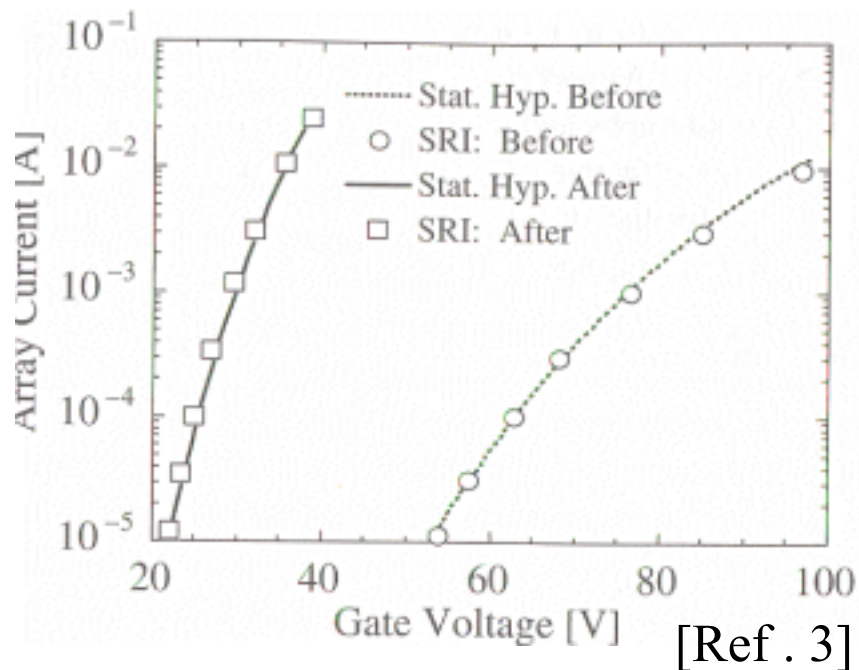
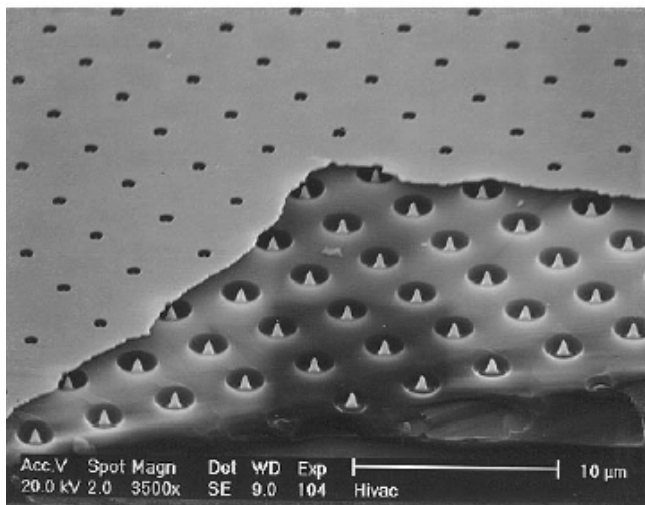


Fig. 8. Emitted current as a function of gate hole radius at 90 V (lower curve) and 140 V (upper curve). Transconductance at 140 V is indicated in bold.

Spindt emitters and arrays (V)



SHOULD

[Ref. 6]



IS

Before:

$$\Delta\Phi = 1 \text{ eV} \quad \Sigma \sim 0.1\%$$

After:

$$\Delta\Phi = 0.2 \text{ eV} \quad \Sigma \sim 20\text{-}40\%$$

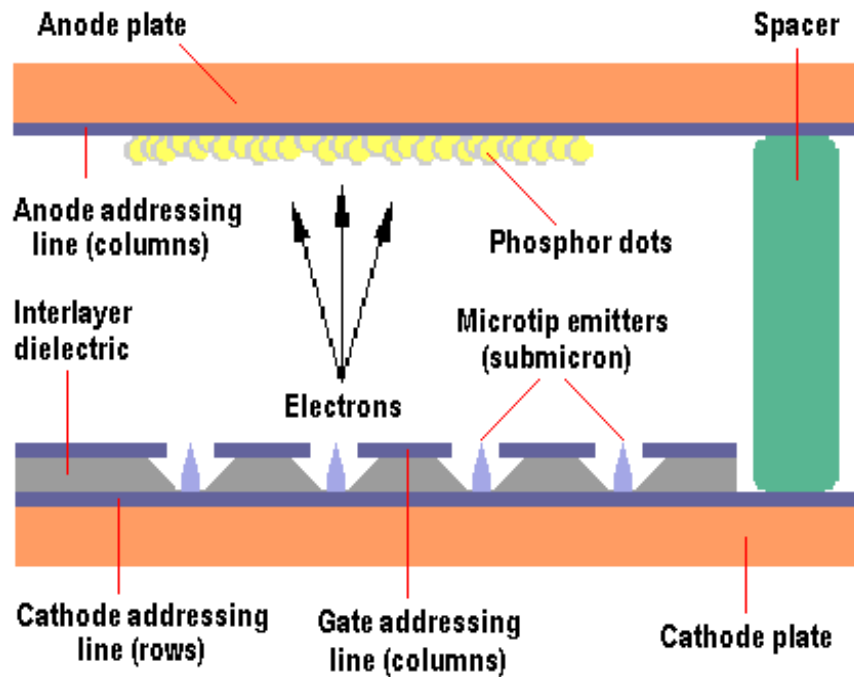
Beyond Spindt emitters (I)

- Problems with simple Spindt emitters
 - Contamination
 - Focusing
 - Uniformity of array fabrication
 - Power consumption

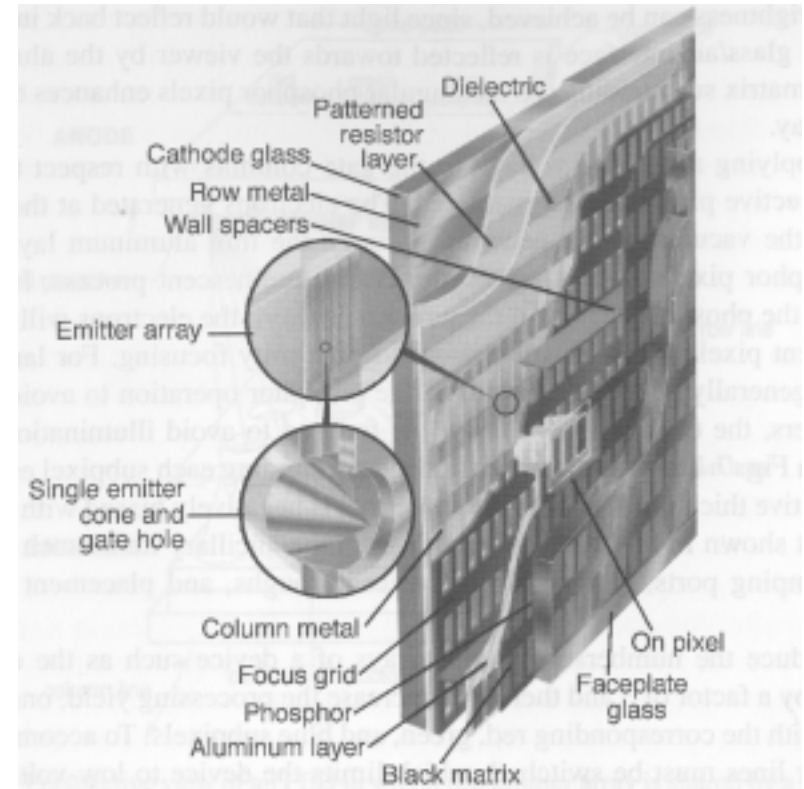
Beyond Spindt emitters (II)

- Solutions
 - ❑ Metal-Insulator-Metal (MIM) emitters
 - ❑ Surface Conduction Emitters (SCE)
 - ❑ Diamond-coated emitters
 - ❑ Carbon nanotube emitters

Field emission display (I)



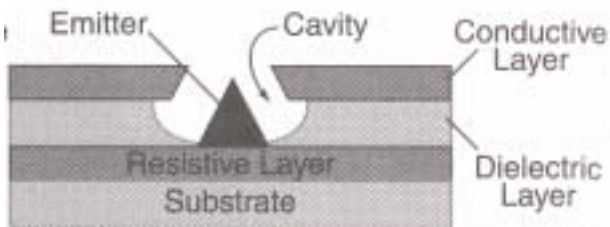
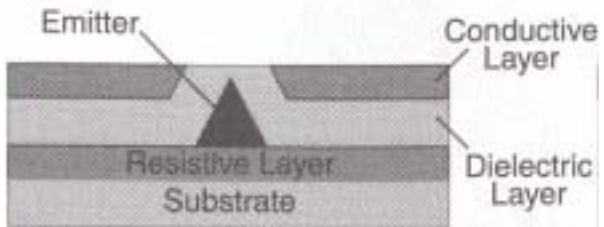
[Ref. 7]



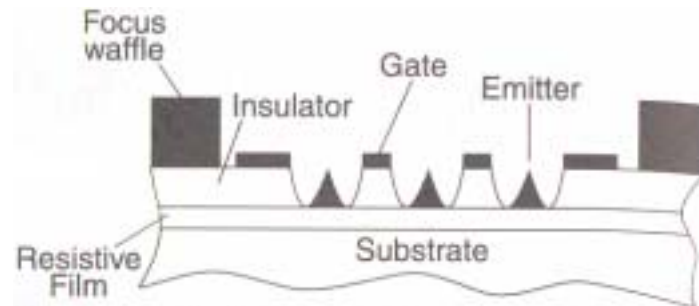
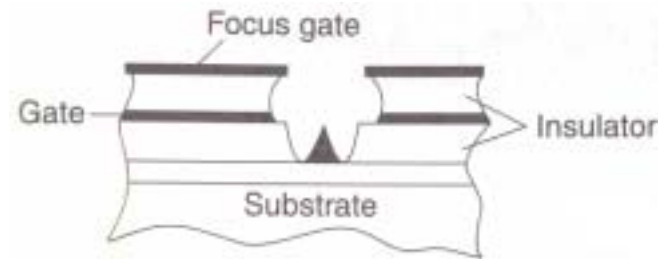
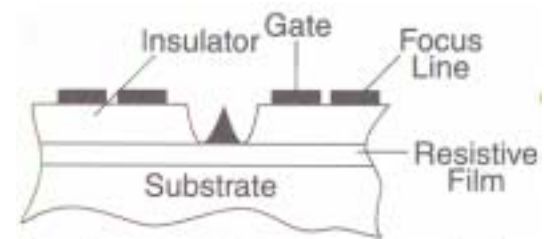
[Ref. 8]

Field emission display (II)

- Large array [Ref. 9]

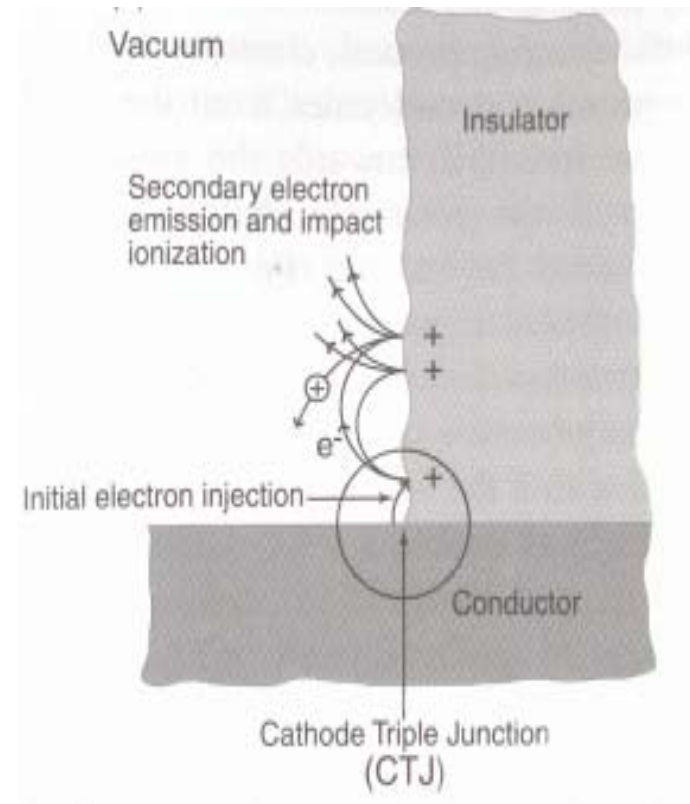
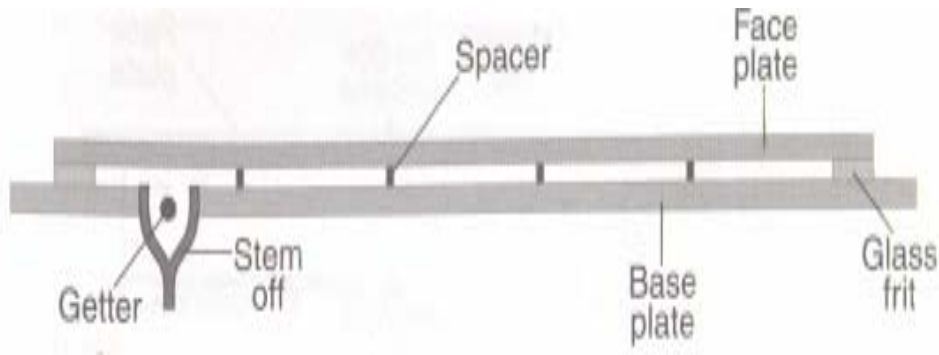


- Beam focusing [Ref. 3]



Field emission display (III)

- Spacers breakdown [Ref. 3]
- Getters [Ref. 3]



Field emission display (IV)

Feature	Thin Film Transistor LCD	Electro-luminescent Display	FED	Plasma Display Panels	OLED Display
Brightness (cd/m ²)	200	100	150 (low-V) >600 (high-V)	300	300
Viewing angle (degrees)	±40	±80	±80	±80	±80
Emission efficacy (lm/W)	3–4	0.5–2	1.5–3 (low-V) 10–15 (high-V)	1.0	10–15
Response time (ms)	30–60	<1	0.01–0.03	1–10	<0.001
Contrast ratio (intrinsic)	>100:1	50:1	300:1	100:1	100:1

[Ref. 3]

Field emission display (V)

Feature	Thin Film Transistor LCD	Electro-luminescent Display	FED	Plasma Display Panels	OLED Display
Number of pixels	1024 × 768	640 × 480	800 × 600	852 × 480	640 × 480
Resolution (mm in pitch)	0.31	0.31	0.27	1.08	0.012
Power consumption (W)	3 (25.4) ^a	6 (25.4)	2 (25.4)	200 (106.7)	6 (15.2)
Maximum screen size in diagonal (cm)	55.9 (22) ^b	25.4 (10)	35.6 (14)	106.7 (42)	15.2 (6)
Panel thickness (mm)	8	10	10	75–100	3

[Ref. 3]

Summary

- An interesting device family
- Special design/fabrication considerations
- Complementary to conventional solid-state devices
- Important applications

References

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